

P_K_.0805.2ST._ Platinum thin film RTD For the automatic assembling on PCBs

| Benefits & Characteris | tics | Product image | |
|---|--------------------------------|---|---|
| Excellent long-term stabil Low self-heating Automatic assembly in la Illustration¹⁾ | | | |
| | | | |
| | H | G | |
| Dimensions | | | |
| Dimensions in mm | L 2.0 ± 0.15 | W 1.25 ± 0.15 | H 0.5 ±0.1 |
| Land pattern in mm | 2.0 ± 0.15 Z 2.70 | 1.25 ± 0.15 G 1.10 | 0.5 ±0.1 X 1.40 |
| Technical Data | | | |
| Electrical Specifications | | | |
| Temperature range | | -50 °C to +150 °C (see ge | neral notes 1.1) |
| Nominal resistance | | 100 Ω at 0 °C, 500 Ω at 0 | °C, 1000 Ω at 0 °C |
| Characteristic | | IEC 60751 | |
| Tolerance class (dependent on | temperature range) | | IST AG reference |
| | | IEC 60751 F0.15 | А |
| | | IEC 60751 F0.3 | В |
| | | IEC 60751 F0.6 | С |
| Temperature coefficient | | 3850 ppm/K | |
| Temperature dependence of m | esistivity | according to IEC 60751: -50 °C to 0 °C $R(T) = R_0 x$ 0 to +150 °C $R(T) = R_0 x$ | (1+AxT + BxT ² + Cx[T-100] x T ³ (1+AxT + BxT ²) |
| | | A = $3.9083 \times 10^{-3} \times ^{\circ}C^{-1}$ B= $-5.775 \times 10^{-7} \times ^{\circ}C^{-2}$ C = $-4.183 \times 10^{-12} \times ^{\circ}C^{-4}$ R _o = resistance value in Ω a T = temperature in accord | t 0°C |

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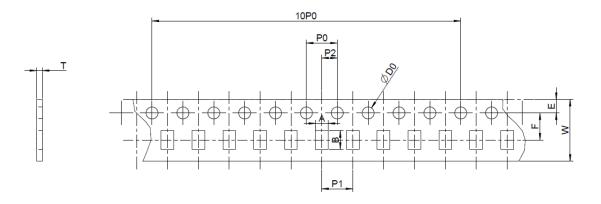


General Specifications

| Pads (soldering connection) | Soft-Termination galvanic tin plated with nickel barrier layer | | |
|---|---|----------|---------|
| Soldering (according to J-STD-002E) see general notes 1.3 | 1. Solderability: Test A and A1 2. Resistance to soldering heat: Test A and A1 | | |
| Measuring current | Pt 100 | Pt 500 | Pt 1000 |
| (Self-heating has to be considered) | 1 mA | 0.5 mA | 0.3 mA |
| Long-term stability: | < 0.04 % at 1000 h at 130 °C | | |
| Taping & Packaging | EIA-481 (for dimensions see general notes 1.2) | | |
| Storage Property | 12 months (original packaging and dry conditions) | | |
| REACH + RoHs Compliance | Yes | | |
| Special | Use in dry environm | ent only | |

General notes

- 1.1 The thermal coefficient of expansion of the circuit board has to be considered
- 1.2 Taping and Packaging:



| ltem | Α | В | w | E | F | PO | P1 | P2 | DO | т | 10P0 |
|-----------|-------|-------|------|-------|-------|------|------|-------|-------|-------|------|
| Dimension | 1.65 | 2.4 | 8.0 | 1.75 | 3.5 | 4.0 | 4.0 | 2.0 | 1.55 | 0.75 | 40.0 |
| min. Tol. | -0.05 | -0.05 | -0.1 | -0.05 | -0.05 | -0.1 | -0.1 | -0.05 | -0.05 | -0.03 | -0.1 |
| max. Tol. | 0.05 | 0.05 | 0.1 | 0.05 | 0.05 | 0.1 | 0.1 | 0.05 | 0.05 | 0.03 | 0.1 |

Dimensions in mm.

Packaging unit in tape and reel, special variants, small quantities or other packaging unit are available on request.



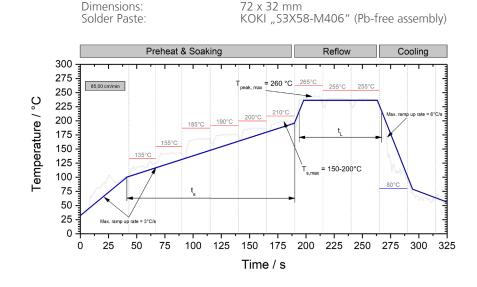
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1.3 Soldering and Reflow profile

For soldering IST AG recommends lead-free solder paste (Material: SnAgCu 96.5/3.0/0.5) and a temperature characteristic (reflow profile) for reflow soldering according to JEDEC J-STD-002E. The solderability was tested with following assembly conditions:

PCB Material: PCB thickness: FR4 (PCB Layer: 2)

1.6 mm



| Profile parameter | Temperature range / °C | Heating rate / °C / s | Time / s |
|-------------------|-------------------------------------|-----------------------|--|
| Ramp to preheat | RT to 150 | 1.9 - 3 | |
| Preaheat /Soak | $T_{s,min} = 100, T_{s,max} = 200$ | 1.9 - 3 | $t_{s, min} = 60, t_{s, max} = 160$ |
| Ramp to Peak | 180 - 255 | 0.6 | |
| Reflow | 250 ± 5 , $T_{peak, max} = 260$ | | 60 to 120, t _{peak, max} = 30 |
| Cooling | 255 - RT | 1.6 - 3 | |

1.4 Important notes:

- The solder or additional fluxes should be halogen-free, mild, and non-activated.
- After soldering, a thorough cleaning with pH-neutral defluxing material is recommended.
- The profile has a significant impact on the solder joint performance, i.e. solderability, wettability and strength.
- The soak profile and all other data serve as a guideline and cannot be regarded as binding statements or guaranteed values. They serve as a starting point for process development. Specifically, a high mix of components or large board sizes might require the development of a different soldering profile.
- Long-term stability in the application and chemical resistance need to be approved by the customer.
- The customer must test and approve the suitability of IST AG sensors in the customer's application.



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Order Information

| Description | Tolerance class | Packaging type | Order number |
|---|------------------------------|---|--------------|
| Other tolerances, values of resistar | nce are available on request | | |
| | | | |
| Nominal resistance: 100 Ω at 0 °C | | | |
| P0K1.0805.2ST.A | IEC 60751 F0.15 (A) | packed in bags | 150043 |
| P0K1.0805.2ST.A.S | IEC 60751 F0.15 (A) | taped on reel (sensor side up) | 150034 |
| POK1.0805.2ST.A.S | IEC 60751 F0.15 (A) | taped on reel (sensor side down) | 150044 |
| POK1.0805.2ST.B | IEC 60751 F0.3 (B) | packed in bags | 152441 |
| POK1.0805.2ST.B.S | IEC 60751 F0.3 (B) | taped on reel (sensor side up) | 150035 |
| POK1.0805.2ST.B.S | IEC 60751 F0.3 (B) | taped on reel (sensor side down) | 152446 |
| P0K1.0805.2ST.C | IEC 60751 F0.6 (C) | packed in bags | 152445 |
| POK1.0805.2ST.C.S | IEC 60751 F0.6 (C) | taped on reel (sensor side up) | 150036 |
| POK1.0805.2ST.C.S | IEC 60751 F0.6 (C) | taped on reel (sensor side down) | 102022 |
| | | | |
| Nominal resistance: 500 Ω at 0 °C | | | |
| P0K5.0805.2ST.A | IEC 60751 F0.15 (A) | packed in bags | 150045 |
| P0K5.0805.2ST.A.S | IEC 60751 F0.15 (A) | taped on reel (sensor side up) | 150040 |
| P0K5.0805.2ST.A.S | IEC 60751 F0.15 (A) | taped on reel (sensor side down) | 150048 |
| POK5.0805.2ST.B | IEC 60751 F0.3 (B) | packed in bags | 150046 |
| POK5.0805.2ST.B.S | IEC 60751 F0.3 (B) | taped on reel (sensor side up) | 150041 |
| POK5.0805.2ST.B.S | IEC 60751 F0.3 (B) | taped on reel (sensor side down) | 150049 |
| P0K5.0805.2ST.C | IEC 60751 F0.6 (C) | packed in bags | 150047 |
| POK5.0805.2ST.C.S | IEC 60751 F0.6 (C) | taped on reel (sensor side up) | 150042 |
| POK5.0805.2ST.C.S | IEC 60751 F0.6 (C) | taped on reel (sensor side down) | 150050 |
| | | | |
| Nominal resistance: 1000 Ω at 0 °C | 2 | | |
| P1K0.0805.2ST.A | IEC 60751 F0.15 (A) | packed in bags | 150028 |
| P1K0.0805.2ST.A.S | IEC 60751 F0.15 (A) | taped on reel (sensor side up) | 150037 |
| P1K0.0805.2ST.A.S | IEC 60751 F0.15 (A) | taped on reel (sensor side down) | 150029 |
| P1K0.0805.2ST.B | IEC 60751 F0.3 (B) | packed in bags | 101865 |
| P1K0.0805.2ST.B.S | IEC 60751 F0.3 (B) | taped on reel (sensor side up) | 150038 |
| P1K0.0805.2ST.B.S | IEC 60751 F0.3 (B) | taped on reel (sensor side down) | 102023 |
| P1K0.0805.2ST.B.S | IEC 60751 F0.3 (B) | taped only, sensor side up (not on reel) | 150078 |
| P1K0.0805.2ST.C | IEC 60751 F0.6 (C) | packed in bags | 102020 |
| P1K0.0805.2ST.C.S | IEC 60751 F0.6 (C) | taped on reel (sensor side up) | 150039 |
| P1K0.0805.2ST.C.S | IEC 60751 F0.6 (C) | taped on reel (sensor side down) | 102024 |



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